

RoHS COMPLIANT

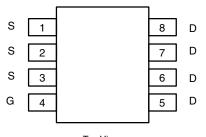
HALOGEN

FREE

**Vishay Siliconix** 

## P-Channel 150-V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)			
- 150	0.295 at V <sub>GS</sub> = - 10 V	- 8.9 <sup>c</sup>	23.2 nC			
	0.315 at V <sub>GS</sub> = - 6 V	- 8.6 <sup>c</sup>	23.2 110			
	SO-8					



Top View

**Ordering Information:** 

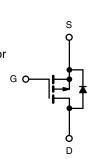
Si4455DY-T1-E3 (Lead (Pb)-free) Si4455DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- 100% R<sub>q</sub> and UIS Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

#### APPLICATIONS

- · Active Clamp in Intermediate DC/ **DC** Power Supplies
- · H-Bridge High Side Switch for Lighting Application



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (	T <sub>A</sub> = 25 °C, unless otł	nerwise noted)		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	- 150	V	
Gate-Source Voltage	V <sub>GS</sub>	± 20	v	
	T <sub>C</sub> = 25 °C		- 2.8	
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C		- 2.3	
Continuous Drain Current $(1_j = 150^{\circ} C)$	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 2 <sup>a, b</sup>	
	T <sub>A</sub> = 70 °C		- 1.6 <sup>a, b</sup>	•
Pulsed Drain Current	I <sub>DM</sub>	- 15	— A	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	1	- 4.9	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 2.5 <sup>a, b</sup>	
Avalanche Current		I <sub>AS</sub>	- 15	
Single-Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	11.25	mJ
	T <sub>C</sub> = 25 °C		5.9	
Mauina Daviar Diasia atian	T <sub>C</sub> = 70 °C		3.8	w
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.1 <sup>a, b</sup>	vv
	T <sub>A</sub> = 70 °C	1	2 <sup>a, b</sup>	
Operating Junction and Storage Temperature Rang	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Based on T<sub>C</sub> = 25 °C.

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THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a, b</sup>	t ≤ 10 s	R <sub>thJA</sub>	33	40	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	17	21	0/10	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. Maximum under steady state conditions is 80 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	•	·	•			
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA	- 150	1		V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 165		
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	i <sub>D</sub> = - 250 μA		- 6.6		mV/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 2		- 4	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zaus Cata Valtana Dusia Ouwant	I <sub>DSS</sub>	V <sub>DS</sub> = - 150 V, V <sub>GS</sub> = 0 V	- 1			
Zero Gate Voltage Drain Current		$V_{DS}$ = - 150 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			- 10	μΑ
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge$ - 5 V, $V_{GS}$ = - 10 V	- 8			Α
	D	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 4 A		0.245	0.295	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 6 V, I <sub>D</sub> = - 3 A		0.260	0.315	Ω
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = 4 A		12		S
Dynamic <sup>b</sup>	•			•	•	•
Input Capacitance	C <sub>iss</sub>			1190		
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 50 V, V <sub>GS</sub> = 0 V, f = 1 MHz		61		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			42		
Total Gate Charge	$Q_{g} \qquad V_{DS} = -75 V,$	$V_{DS} = -75 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3 \text{ A}$		27.5	42	
				23.2	35	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = -75 \text{ V}, V_{GS} = -6 \text{ V}, I_D = -3 \text{ A}$		5.4		nC
Gate-Drain Charge	Q <sub>gd</sub>			8.4		
Gate Resistance	Rg	f = 1 MHz		6.1	9.2	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			20	30	
Rise Time	t <sub>r</sub>	$\begin{split} V_{DD} &= -\ 75\ V,\ R_L = 25\ \Omega\\ I_D &\cong -\ 3\ A,\ V_{GEN} = -\ 6\ V,\ R_g = 1\ \Omega \end{split}$		95	145	-
Turn-Off DelayTime	t <sub>d(off)</sub>			38	60	
Fall Time	t <sub>f</sub>			34	51	
Turn-On Delay Time	t <sub>d(on)</sub>			11	18	ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 75 V, $R_L$ = 25 $\Omega$		28	42	-
Turn-Off DelayTime	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ - 3 A, $\text{V}_\text{GEN}$ = - 10 V, $\text{R}_\text{g}$ = 1 $\Omega$		52	78	
Fall Time	t <sub>f</sub>			35	53	
Drain-Source Body Diode Characterist	ics					
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 13	۸
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				- 15	A
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 3 A		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			65	90	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = - 4 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		180	270	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$_{\rm F}$ = - 4 A, ui/ut = 100 A/µs, 1 <sub>J</sub> = 25 °C		45		
Reverse Recovery Rise Time	t <sub>b</sub>	1		20		ns

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

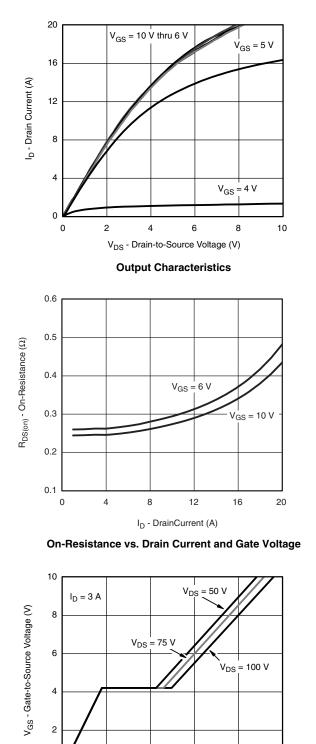
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

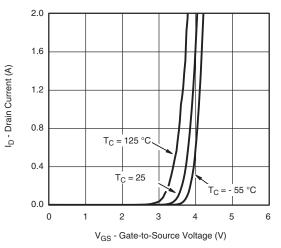
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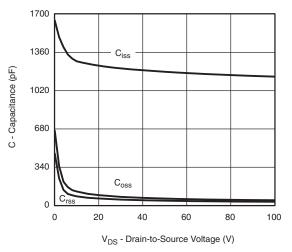
## Si4455DY Vishay Siliconix

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

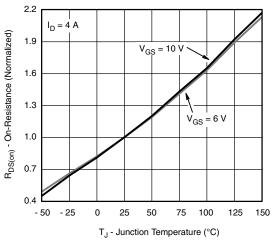




**Transfer Characteristics** 



Capacitance



**On-Resistance vs. Junction Temperature** 

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0

0

6

12

18

Q<sub>q</sub> - TotalGateCharge(nC)

**Gate Charge** 

24

30

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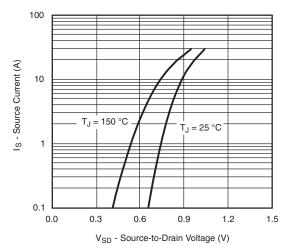
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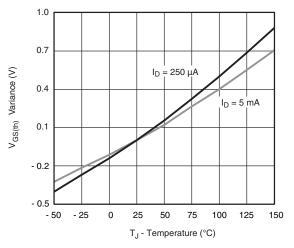
## Vishay Siliconix



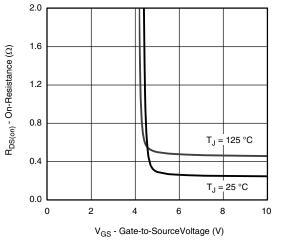
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



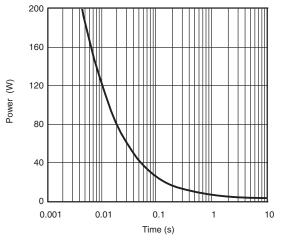
Source-Drain Diode Forward Voltage



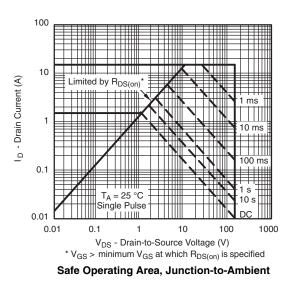
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



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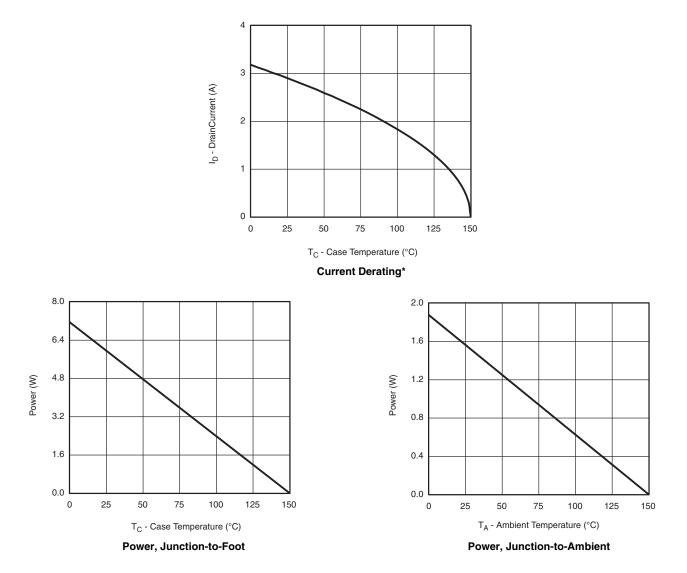
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



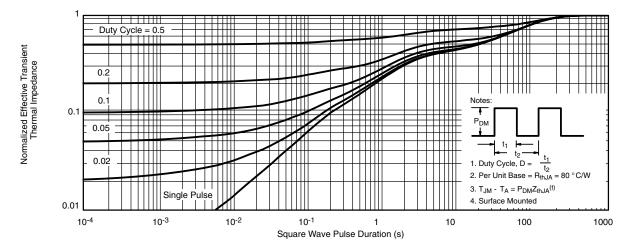
\* The power dissipation P<sub>D</sub> is based on T<sub>J(max.)</sub> = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heats inking is used. It is used to determine the current rating, when this rating falls below the package limit.

## Si4455DY

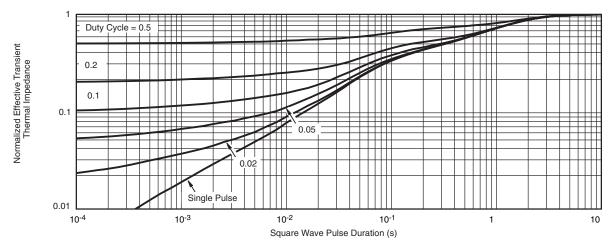


## Vishay Siliconix

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?68631">www.vishay.com/ppg?68631</a>.

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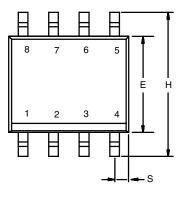


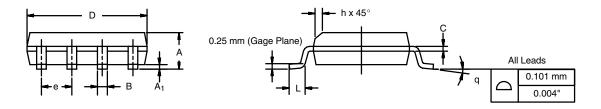
# Package Information

Vishay Siliconix

### SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





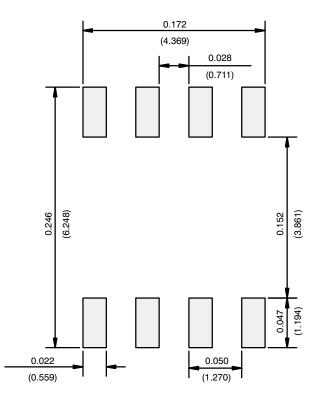
	MILLIM	IETERS	INCHES			
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050	0.050 BSC		
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

# **Application Note 826**

Vishay Siliconix



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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